

Pending

Active

- L3: (76) 361/805-811.ccls. and (surface adj mount\$3) and trace
- L4: (8) Backward citation search 2
- L5: (7) Forward citation search 1
- L6: (4) Forward citation search 2
- L7: (8) Backward citation search 3
- L8: (4) Forward citation search 3
- L9: (8) Backward citation search 4
- L10: (67) 361/782.ccls. and (surface adj mount\$3) and trace

Failed

Saved

- S3: (1138) (circuit adj board) and trace and (component near3 (cap or electrode or te
- S1: (12) ("5552757"|"5933307"|"6023028"|"6337798"|"6690558"|"7034652").PN.
- S2: (17708) (circuit adj board) and trace and component and parallel
- S4: (173) "361"/\$.ccls. and S3
- S5: (32) Backward citation search 1

Favorites

Tagged (6)

UDC

Queue

Trash

Search

DBs: US-PGPUB; USPAT; USOCR; EPO; IPO; DERWENT

Default operator: OR

Bonds

highlight all hit terms initially

361/782.ccls. and (surface adj mount\$3) and trace

U	1	Document ID	Issue Date	Pages	Title	Current OR	Current XRef	Retrieval Clas	Inventor
22	<input checked="" type="checkbox"/>	US 20020185308	20021212		Depopulation of a ball grid array to allow via placement	174/260	174/250; 174/262;	361/782	Cornelius, William P. et al.
23	<input checked="" type="checkbox"/>	US 20020172025	20021121		Structure and method for fabrication of a leadless chip carrier with embedded	361/767	174/252; 174/262;	361/782	Megahed, Mohamed et al.
24	<input checked="" type="checkbox"/>	US 20020089832	20020711		Semiconductor package with flash-proof device	361/760	257/724; 257/787;	361/782	Huang, Chien-Ping
25	<input type="checkbox"/>	US 7224052 B2	20070529	38	IC card with controller and memory chips	257/679	257/685; 257/686;	361/782	Nishizawa; Hirotaka et al.
26	<input type="checkbox"/>	US 7133294 B2	20061107	29	Integrated circuit packages with sandwiched capacitors	361/782	257/691; 257/724;	361/782	Patel; Priyavadan R. et al.
27	<input type="checkbox"/>	US 7102892 B2	20060905	29	Modular integrated circuit chip carrier	361/770	257/686; 257/724;	361/782	Kledzik; Kenneth J. et al.
28	<input type="checkbox"/>	US 6900991 B2	20050531	29	Electronic assembly with sandwiched capacitors and methods of manufacture	361/782	257/724; 257/E21.511;	361/782	Patel; Priyavadan R. et al.
29	<input type="checkbox"/>	US 6900529 B2	20050531	13	Electronic module having a three dimensional array of carrier-mounted	257/686	257/675; 257/707;	361/782	Kledzik; Kenneth J. et al.
30	<input type="checkbox"/>	IIC 0924427 P2	20041229	44	Method for depopulating of a ball grid	200/810	174/250; 174/260;	361/782	Cornelius, William P. et al.

Help  Details  HTML

NUM

Ready